



Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-1 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x	Form Type * Distribute	Declaration Class * Class 4 - RoHS Yes/No, JIG Format Substances, Mfg Info
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Supplier Information

Company Name * IDT	Company Unique ID	Unique ID Authority	Response Date * 2009-11-19	Response Document ID RM400				
Contact Name * CS Phek	Title - Contact Engineer	Phone - Contact * 604-613-2538	Email - Contact * csphek@idt.com	Duplicate Contact -> Authorized Representative				
Authorized Representative * CS Phek	Title - Representative Engineer	Phone - Representative * 604-613-2538	Email - Representative * csphek@idt.com	Supplier Comments or URL for Additional Information				
Requester Item Number	Mfr Item Number	Mfr Item Name RM400	Effective Date 2009-11-19	Version 0	Manufacturing Site ATT	Weight * 1,652	UOM mg	Unit Type Each
Alternate Recommendation	Alternate Item Comments							

Manufacturing Process Information

Terminal Plating / Grid Array Material Tin/Silver/Copper (Sn/Ag/Cu)	Terminal Base Alloy Not Applicable	J-STD-020 MSL Rating 4	Peak Process Body Temperature 245 C	Max Time at Peak Temperature 30 seconds	Number of Reflow Cycles 3
Comments					

Save the fields in this form to a file

Export Data

Import fields from a file into this form

Import Data

Clear all of the fields on this form

Reset Form

Lock the fields on this form to prevent changes

Lock Supplier Fields

RoHS Material Composition Declaration

Declaration Type *

Simplified

RoHS Directive 2002/95/EC

RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

RoHS Declaration *

4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions

Supplier Acceptance *

Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Exemption List Version

EL2006/690/EC

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15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.

Declaration Signature

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Joint Industry Guide (JIG) Material Composition Declaration for Electronic Products

Instructions: Declare whether the item substances exceed the threshold levels shown in the table and report accordingly. Where threshold levels include the words "intentionally added", substances must be declared if they are added intentionally, regardless of threshold level. For each RoHS substance, identified with dual asterisks (**), report the worst case PPM at the homogeneous material level and optionally the total weight of the substance in the item. For all remaining (non-RoHS) JIG A & B substances, and any additional substances, report the total weight and optionally the PPM at the part level for each item.

				JIG A autofill - No	JIG B autofill - No	All autofill - No		
JIG	Category Name	Threshold Level	Above Threshold Level?	If yes, enter total weight and worse case PPM			Description of Use	
Level	As defined in the Joint Industry Guide	Intentionally added or PPM	Yes/No	Weight	UoM	PPM		
A	Asbestos	Intentionally Added	No		mg			
A	Certain Azo colorants	Intentionally Added	No		mg			
A	Cadmium/Cadmium Compounds **	75 PPM or Intentionally Added	No		mg			
A	Hexavalent Chromium/Hexavalent Chromium Compounds **	1000 PPM or Intentionally Added	No		mg			
A	Lead/Lead Compounds **	1000 PPM or Intentionally Added	Yes	5.48	mg	950,000	Solder bump	
A	Lead/Lead Compounds - PVC Cables and Wires Only **	300 PPM	No		mg			
A	Mercury/Mercury Compounds **	1000 PPM or Intentionally Added	No		mg			
A	Ozone Depleting Substances - Class I (CFCs, HBFCs, etc.)	Intentionally Added	No		mg			
A	Ozone Depleting Substances - Class II (HCFCs)	1000 PPM	No		mg			
A	Polybrominated Biphenyls (PBBs) **	1000 PPM or Intentionally Added	No		mg			
A	Polybrominated Diphenylethers (PBDEs) **	1000 PPM or Intentionally Added	No		mg			
A	Polychlorinated Biphenyls (PCBs)	Intentionally Added	No		mg			
A	Polychlorinated Naphthalenes (> 3 chlorine atoms)	Intentionally Added	No		mg			
A	Radioactive Substances	Intentionally Added	No		mg			
A	Certain Shortchain Chlorinated Paraffins	Intentionally Added	No		mg			
A	Tributyl Tin (TBT) and Triphenyl Tin (TPT)	Intentionally Added	No		mg			
A	Tributyl Tin Oxide (TBTO)	Intentionally Added	No		mg			
B	Antimony/Antimony Compounds	1000 PPM	No		mg			
B	Arsenic/Arsenic Compounds	1000 PPM	No		mg			
B	Beryllium/Beryllium Compounds	1000 PPM	No		mg			
B	Bismuth/Bismuth Compounds	1000 PPM	No		mg			
B	Brominated Flame Retardants (other than PBBs or PBDEs)	1000 PPM	No		mg			
B	Nickel (external applications only)	1000 PPM	No		mg			
B	Certain Phthalates	1000 PPM	No		mg			
B	Selenium/Selenium Compounds	1000 PPM	No		mg			
B	Polyvinyl Chloride (PVC)	1000 PPM	No		mg			

OTHER Material Composition Declaration

Requester Instructions: The requester can optionally include additional substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances. The requester should enter additional substances as well as the threshold levels that specify the substance at the item level.

Supplier Instructions: Explicitly declare whether the item exceed the threshold level by selecting Yes or No. If the maximum concentration of any substance exceeds the threshold levels defined by the requester, then the substance content must be reported in total weight and/or worst case PPM, along with a description of material use.

JIG	Category Name	Threshold Level
Other	As defined by the Supplier	Defined by the Supplier
+ -		
Add Other Material Composition to JIG Tab		Clear Other Material Composition in JIG Tab